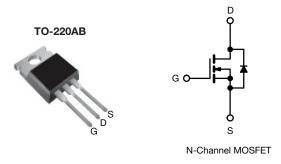
# SiHP065N60E

**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.057				
Q <sub>g</sub> max. (nC)	74					
Q <sub>gs</sub> (nC)	19					
Q <sub>gd</sub> (nC)	15					
Configuration	Single					

### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Load (Ph) free and helegen free	SiHP065N60E-BE3 <sup>a</sup>
Lead (Pb)-free and halogen-free	SiHP065N60E-GE3

#### Note

a. "-BE3" denotes alternate manufacturing location

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	v
Gate-source voltage	V <sub>GS</sub>	± 30	V		
Continuous drain current (T <sub>J</sub> = 150 °C)	V at 10 V	$T_{GS}$ at 10 V $\frac{T_C = 25 °C}{T_C = 100 °C}$	- I <sub>D</sub> -	40	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		25	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	116	
Linear derating factor				2.0	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	226	mJ
Maximum power dissipation			P <sub>D</sub>	250	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> = 125 °C			100	
Reverse diode dV/dt <sup>d</sup>			dV/dt	50	V/ns
Soldering recommendations (peak temperature) <sup>c</sup>	For	10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.0 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , dl/dt = 400 A/µs, starting  $T_J$  = 25 °C

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HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS						
PARAMETER	SYMBOL	TYP. MAX.			UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			00 AN		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.5			°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	uplace otherwi	so noted)					
<b>PARAMETER</b> $(1) = 23 \circ 0$ ,	SYMBOL	se noted) TEST CONDITIONS MIN.		TYP.	MAX.	UNI	
Static	•	-		•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$			0.72	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3	-	5	V
	1	V <sub>GS</sub> =	± 20 V	-	-	°C/W <b>'YP. MAX.</b>  0.72 - - 5 - ±100 - ±1 - 10 .057 0.065 12 - 700 -	nA
Gate-source leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 30 V		-	-	± 1	μA
		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA
Zero gate voltage drain current	IDSS	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$		-	-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 16 A	-	0.057	0.065	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 20 V	/, I <sub>D</sub> = 16 A	-	12	-	S
Dynamic	-						
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2700	-	
Output capacitance	C <sub>oss</sub>			-	102	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-	
Effective output capacitance, energy	_						pF

Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	93	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	593	-	
Total gate charge	Qg			-	49	74	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_D = 16 \text{ A}, V_{DS} = 480 \text{ V}$	-	19	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	15	-	
Turn-on delay time	t <sub>d(on)</sub>			-	28	56	
Rise time	t <sub>r</sub>		V <sub>DD</sub> = 480 V, I <sub>D</sub> = 16 A,		46	92	ns
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	54	108	
Fall time	t <sub>f</sub>			-	13	26	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	А
Pulsed diode forward current	I <sub>SM</sub>			-	-	116	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	$T_J = 25 \text{ °C}, I_S = 16 \text{ A}, V_{GS} = 0 \text{ V}$		-	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	382	764	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \ ^{\circ}C, I_F = I_S = 16 \ A,$ dI/dt = 100 A/µs, V <sub>R</sub> = 400 V		-	7.1	14.2	μC
Reverse recovery current	I <sub>RRM</sub>			-	34	-	Α

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS





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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

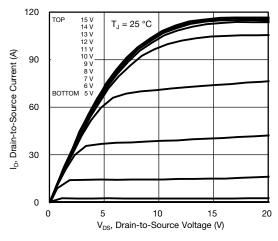
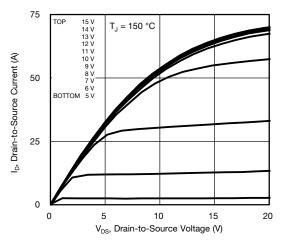


Fig. 1 - Typical Output Characteristics





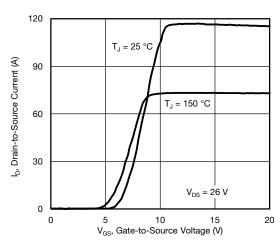


Fig. 3 - Typical Transfer Characteristics

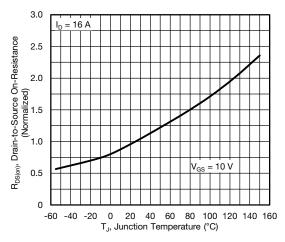


Fig. 4 - Normalized On-Resistance vs. Temperature

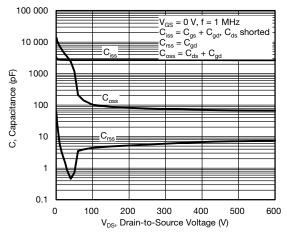


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

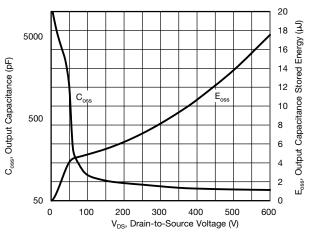


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91938

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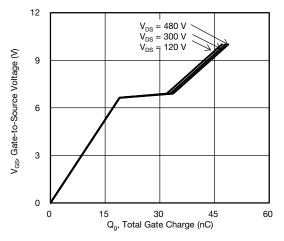


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

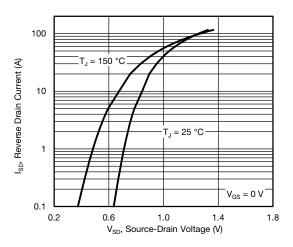


Fig. 8 - Typical Source-Drain Diode Forward Voltage

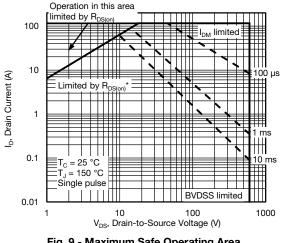


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4

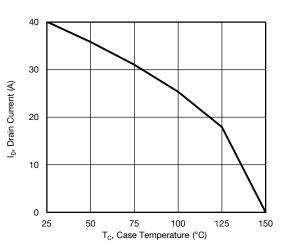


Fig. 10 - Maximum Drain Current vs. Case Temperature

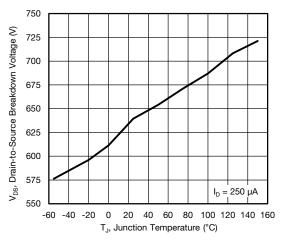
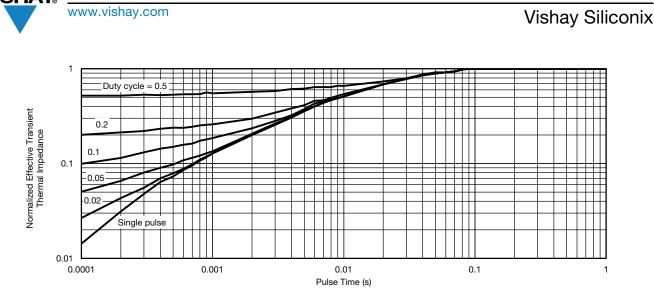


Fig. 11 - Temperature vs. Drain-to-Source Voltage





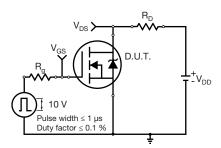


Fig. 13 - Switching Time Test Circuit

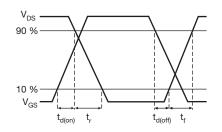


Fig. 14 - Switching Time Waveforms

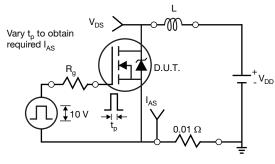


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

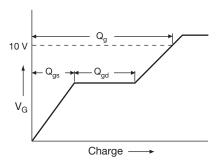


Fig. 17 - Basic Gate Charge Waveform

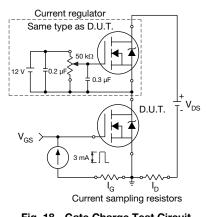
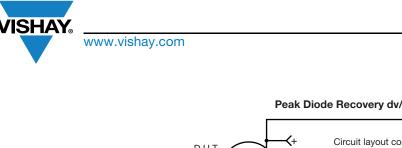


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit

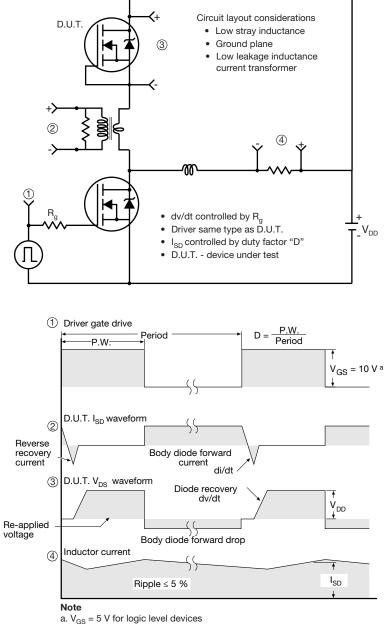


Fig. 19 - For N-Channel

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